

TPS2112A TPS2113A SBVS045 – MARCH 2004

# **AUTOSWITCHING POWER MUX**

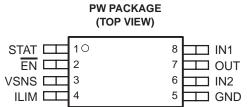
# **FEATURES**

- Two-Input, One-Output Power Multiplexer With Low r<sub>DS(on)</sub> Switches:
  - 84 mΩ Typ (TPS2113A)
  - 120 m $\Omega$  Typ (TPS2112A)
- Reverse and Cross-Conduction Blocking
- Wide Operating Voltage Range . . . . 2.8 V to 5.5 V
- Low Standby Current . . . . 0.5-µA Typ
- Low Operating Current . . . . 55-µA Typ
- Adjustable Current Limit
- Controlled Output Voltage Transition Times, Limits Inrush Current and Minimizes Output Voltage Hold-Up Capacitance
- CMOS- and TTL-Compatible Control Inputs
- Auto-Switching Operating Mode
- Thermal Shutdown
- Available in a TSSOP-8 Package

# DESCRIPTION

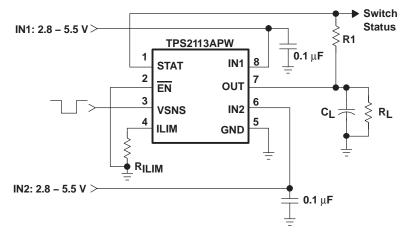
# APPLICATIONS

- PCs
- PDAs
- Digital Cameras
- Modems
- Cell Phones
- Digital Radios
- MP3 Players



The TPS211xA family of power multiplexers enables seamless transition between two power supplies, such as a battery and a wall adapter, each operating at 2.8–5.5 V and delivering up to 1 A. The TPS211xA family includes extensive protection circuitry, including user-programmable current limiting, thermal protection, inrush current control, seamless supply transition, cross-conduction blocking, and reverse-conduction blocking. These features greatly simplify designing power multiplexer applications.

#### TYPICAL APPLICATION



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# TPS2112A TPS2113A



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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

# AVAILABLE OPTIONS

FEATURE       Current Limit Adjustment Range       Switching Madea		TPS2110A	TPS2111A	TPS2112A	TPS2113A	TPS2114A	TPS2115A
Current Limit Adjustment Range		0.31–0.75A	0.63–1.25A	0.31–0.75A	0.63–1.25A	0.31–0.75A	0.63–1.25A
Switching Modeo	Manual	Yes	Yes	No	No	Yes	Yes
Switching Modes	Automatic	Yes	Yes	Yes	Yes	Yes	Yes
Switch Status Output		No	No	Yes	Yes	Yes	Yes
Package		TSSOP-8	TSSOP-8	TSSOP-8	TSSOP-8	TSSOP-8	TSSOP-8

#### **ORDERING INFORMATION**

TA	PACKAGE	ORDERING NUMBER(1)	MARKINGS
1000 10 0500		TPS2112APW	2112A
–40°C to 85°C	TSSOP-8 (PW)	TPS2113APW	2113A

(1) The PW package is available taped and reeled. Add an **R** suffix to the device type (e.g., TPS2112APWR) to indicate tape and reel.

#### PACKAGE DISSIPATION RATINGS

PACKAGE	DERATING FACTOR ABOVE	T <sub>A</sub> ≤ 25°C	T <sub>A</sub> = 70°C	T <sub>A</sub> = 85°C
	T <sub>A</sub> = 25°C	POWER RATING	POWER RATING	POWER RATING
TSSOP-8 (PW)	3.9 mW/°C	387 mW	213 mW	155 mW

#### **ABSOLUTE MAXIMUM RATINGS**

over operating free-air temperature range unless otherwise noted<sup>(1)</sup>

		TPS2112A, TPS2113A
Input voltage range at pins IN1, IN2,	EN, VSNS, ILIM <sup>(2)</sup>	–0.3 V to 6 V
Output voltage range, VO(OUT), VO(	STAT) <sup>(2)</sup>	–0.3 V to 6 V
Output sink current, IO(STAT)	_	5 mA
Continuous output current, IO	TPS2112A	0.9 A
Continuous output current, IO	TPS2113A	1.5 A
Continuous total power dissipation		See Dissipation Rating Table
Operating virtual junction temperature	e range, TJ	-40°C to 125°C
Storage temperature range, T <sub>stg</sub>		−65°C to 150°C
Lead temperature soldering 1,6 mm (	1/16 inch) from case for 10 seconds	260°C

(1) Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltages are with respect to GND.

#### **RECOMMENDED OPERATING CONDITIONS**

		MIN	MAX	UNIT
	V <sub>I(IN2)</sub> ≥ 2.8 V	1.5	5.5	
Input voltage at IN1, VI(IN1)	V <sub>I(IN2)</sub> < 2.8 V	2.8	5.5	V
	V <sub>I(IN1)</sub> ≥ 2.8 V	1.5	5.5	v
Input voltage at IN2, VI(IN2)	VI(IN1) < 2.8 V	2.8	5.5	V
Input voltage, VI(EN), VI(VSNS)		0	5.5	V
	TPS2112A	0.31	0.75	
Current limit adjustment range, IO(OUT)	TPS2113A	0.63	1.25	A
TPS2112A		-40	125	°C

# **ELECTROSTATIC DISCHARGE (ESD) PROTECTION**

	MIN	MAX	UNIT
Human body model		2	kV
CDM		500	V

#### **ELECTRICAL CHARACTERISTICS**

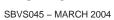
over recommended operating junction temperature range,  $V_{I(IN1)} = V_{I(IN2)} = 5.5 \text{ V}$ ,  $R_{ILIM} = 400 \Omega$  (unless otherwise noted)

PARAMETER		TEOT	NONDITIONS	TPS2112A		TPS2113A			UNUT		
		IESIC	CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	UNIT	
POWER SW	ЛТСН										
		T 0500	$V_{I(IN1)} = V_{I(IN2)} = 5.0 V$		120	140		84	110		
	Drain-source IL = 500 mA	$I_{J} = 25^{\circ}C,$	$V_{I(IN1)} = V_{I(IN2)} = 3.3 V$		120	140		84	110	mΩ	
r <sub>DS(on)</sub> (1)			$V_{I(IN1)} = V_{I(IN2)} = 2.8 V$		120	140		84	110		
<sup>1</sup> DS(on) <sup>(1)</sup>			T. 40500	$V_{I(IN1)} = V_{I(IN2)} = 5.0 V$			220			150	
		$V_{I(IN1)} = V_{I(IN2)} = 3.3 V$			220			150	mΩ		
			V <sub>I(IN1)</sub> = V <sub>I(IN2)</sub> = 2.8 V			220			150		

 (1) The TPS211xA can switch a voltage as low as 1.5 V as long as there is a minimum of 2.8 V at one of the input power pins. In this specific case, the lower supply voltage has no effect on the IN1 and IN2 switch on-resistances.

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
LOGIC INPUTS (EN)					
VIH High-level input voltage		2			V
VIL Low-level input voltage				0.7	V
land the summary	EN = High, sink current			1	
Input current	EN = Low, source current	0.5	1.4	5	μA
SUPPLY AND LEAKAGE CURRE	NTS				
	$V_{I(VSNS)} = 1.5 \text{ V}, \overline{EN} = \text{Low (IN1 active)}, V_{I(IN1)} = 5.5 \text{ V}, V_{I(IN2)} = 3.3 \text{ V}, I_{O(OUT)} = 0 \text{ A}$		55	90	
Supply current from IN1	$V_{I(VSNS)} = 1.5 \text{ V}, \overline{EN} = \text{Low (IN1 active)}, V_{I(IN1)} = 3.3 \text{ V}, V_{I(IN2)} = 5.5 \text{ V}, I_{O(OUT)} = 0 \text{ A}$		1	12	μA
(operating)				75	μΛ
	$V_{I(VSNS)} = 0 \text{ V}, \overline{EN} = \text{Low (IN2 active)}, V_{I(IN1)} = 3.3 \text{ V}, V_{I(IN2)} = 5.5 \text{ V}, I_{O(OUT)} = 0 \text{ A}$			1	
	$V_{I(VSNS)} = 1.5 \text{ V}, \ \overline{EN} = \text{Low (IN1 active)}, \ V_{I(IN1)} = 5.5 \text{ V}, \ V_{I(IN2)} = 3.3 \text{ V}, \ I_{O(OUT)} = 0 \text{ A}$			1	
Supply current from IN2	$V_{I(VSNS)} = 1.5 \text{ V}, \text{ EN} = \text{Low (IN1 active)}, V_{I(IN1)} = 3.3 \text{ V}, V_{I(IN2)} = 5.5 \text{ V}, I_{O(OUT)} = 0 \text{ A}$			75	A
(operating)	$V_{I(VSNS)} = 0 \text{ V}, \overline{EN} = \text{Low (IN2 active)}, V_{I(IN1)} = 5.5 \text{ V}, V_{I(IN2)} = 3.3 \text{ V}, I_{O(OUT)} = 0 \text{ A}$		1	12	μΑ
	$V_{I(VSNS)} = 0 \text{ V}, \overline{EN} = \text{Low (IN2 active)}, V_{I(IN1)} = 3.3 \text{ V}, V_{I(IN2)} = 5.5 \text{ V}, I_{O(OUT)} = 0 \text{ A}$		55	90	
Quiescent current from IN1	$\overline{\text{EN}}$ = High (inactive), $V_{I(IN1)}$ = 5.5 V, $V_{I(IN2)}$ = 3.3 V, $I_{O(OUT)}$ = 0 A		0.5	2	۸
(STANDBY)	EN = High (inactive), V <sub>I(IN1)</sub> = 3.3 V, V <sub>I(IN2)</sub> = 5.5 V, I <sub>O(OUT)</sub> = 0 A			1	μA
Quiescent current from IN2	$EN$ = High (inactive), $V_{I(IN1)}$ = 5.5 V, $V_{I(IN2)}$ = 3.3 V, $I_{O(OUT)}$ = 0 A			1	
(STANDBY)	$\overline{\text{EN}}$ = High (inactive), $V_{I(IN1)}$ = 3.3 V, $V_{I(IN2)}$ = 5.5 V, $I_{O(OUT)}$ = 0 A		0.5	2	μA
Forward leakage current from IN1 (measured from OUT to GND)	$\overline{EN}$ = High (inactive), V <sub>I(IN1)</sub> = 5.5 V, IN2 open, V <sub>O(OUT)</sub> = 0 V (shorted), T <sub>J</sub> = 25°C		0.1	5	μΑ
Forward leakage current from IN2 (measured from OUT to GND)	$\overline{\text{EN}}$ = High (inactive), V <sub>I(IN2)</sub> = 5.5 V, IN1 open, V <sub>O(OUT)</sub> = 0 V (shorted), T <sub>J</sub> = 25°C		0.1	5	μΑ
Reverse leakage current to INx (measured from INx to GND)	$\overline{\text{EN}}$ = High (inactive), $V_{I(INx)}$ = 0 V, $V_{O(OUT)}$ = 5.5 V, $T_{J}$ = 25°C		0.3	5	μΑ
STAT OUTPUT					
Leakage current	V <sub>O(STAT)</sub> = 5.5 V		0.01	1	μA
Saturation voltage	$I_{I(STAT)} = 2 \text{ mA}$ , IN1 switch is on		0.13	0.4	V
Deglitch time (falling edge only)			150		μs

# **TPS2112A TPS2113A**





**ELECTRICAL CHARACTERISTICS (Continued)** over recommended operating junction temperature range,  $V_{I(IN1)} = V_{I(IN2)} = 5.5$  V,  $R_{ILIM} = 400 \Omega$  (unless otherwise noted)

	PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
CUR	RENT LIMIT CIRCUIT						
		TPS2112A	R <sub>ILIM</sub> = 400 Ω	0.51	0.63	0.80	
	1P52112A	R <sub>ILIM</sub> = 700 Ω	0.30	0.36	0.50	٨	
	Current limit accuracy	TPS2113A	R <sub>ILIM</sub> = 400 Ω	0.95	1.25	1.56	A
		1F32113A	R <sub>ILIM</sub> = 700 Ω	0.47	0.71	0.99	
td	Current limit settling time <sup>(1)</sup>		Time for short-circuit output current to settle within 10% of its steady state value.		1		ms
	Input current at ILIM		V <sub>I(ILIM)</sub> = 0 V, I <sub>O(OUT)</sub> = 0 A	-15		0	μA

(1) Not tested in production.

TEST CONDITIONS	MIN	TYP	MAX	UNIT
L				
VI(VSNS) ↑	0.78	0.8	0.82	.,
VI(VSNS)↓	0.735	0.755	0.775	V
	30		60	mV
	90	150	220	μs
0 V ≤ V <sub>I(VSNS)</sub> ≤ 5.5 V	-1		1	μΑ
	·			
Falling edge	1.15	1.25		.,
Rising edge		1.30	1.35	V
	30	57	65	mV
Falling edge	2.4	2.53		
Rising edge		2.58	2.8	V
	30	50	75	mV
Falling edge		110		μs
	$\forall I(VSNS) \uparrow$ $\forall I(VSNS) \downarrow$ 0 V ≤ VI(VSNS) ≤ 5.5 V         Falling edge         Rising edge         Falling edge         Rising edge         Falling edge         Falling edge	$\bigvee_{I(VSNS)}$ 0.78 $\bigvee_{I(VSNS)}$ 0.735303090900 ∨ ≤ ∨ <sub>I(VSNS)</sub> ≤ 5.5 ∨-1Falling edge11.15Rising edge30Falling edge2.4Rising edge30130930930130930930930930	$\begin{tabular}{ c c c c c } \hline V_{I}(VSNS) \uparrow & 0.78 & 0.8 \\ \hline V_{I}(VSNS) \downarrow & 0.735 & 0.755 \\ \hline & & & & & & & & & & & & & & & & & &$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

PARAMETER		Т	EST CONDITIONS	MIN	TYP	MAX	UNIT	
REVERSE CC	REVERSE CONDUCTION BLOCKING							
$\Delta VO(I_block)$	Minimum output-to-input voltage difference to block switching	0 V. Connect OUT 1-kΩ resistor. Let E	= 3.3 V and $V_{I}(IN2) = V_{I}(VSNS) =$ to a 5 V supply through a series $\overline{N} = Iow$ . Slowly decrease the I OUT connects to IN1.	80	100	120	mV	
	PARAMETER		TEST CONDITIONS	MIN	тур	ΜΔΧ		

PARAMETER	TEST CONDITIONS	IVIIN	ITP	IVIAX	UNIT
THERMAL SHUTDOWN					
Thermal shutdown threshold(1)	TPS211xA is in current limit.	135			
Recovery from thermal shutdown(1)	TPS211xA is in current limit.	125			°C
Hysteresis(1)			10		
IN2-IN1 COMPARATORS					
Hysteresis of IN2–IN1 comparator		0.1		0.2	V
Deglitch of IN2–IN1 comparator (both $\uparrow\downarrow$ )(1)		10	20	50	μs

(1) Not tested in production.

# SWITCHING CHARACTERISTICS

over recommended operating junction temperature range,  $V_{I(IN1)} = V_{I(IN2)} = 5.5$  V,  $R_{ILIM} = 400 \Omega$  (unless otherwise noted)

DADAMETED		7507.00		TPS2112A			TPS2113A			
	PARAMETER	TEST CO	NDITIONS	MIN TYP MAX			MIN	TYP	MAX	UNIT
POWER SWITCH										
t <sub>r</sub>	Output rise time from an enable <sup>(1)</sup>	$V_{I(IN1)} = V_{I(IN2)} = 5 V,$ $V_{I(VSNS)} = 1.5 V$	T <sub>J</sub> = 25°C, C <sub>L</sub> = 1 μF, I <sub>L</sub> = 500 mA, See Figure 1(a)	0.5	1.0	1.5	1	1.8	3	ms
t <sub>f</sub>	Output fall time from a disable <sup>(1)</sup>	$V_{I(IN1)} = V_{I(IN2)} = 5 V,$ $V_{I(VSNS)} = 1.5 V$	T <sub>J</sub> = 25°C, C <sub>L</sub> = 1 μF, I <sub>L</sub> = 500 mA, See Figure 1(a)	0.35	0.5	0.7	0.5	1	2	ms
tt	Transition time(1)	IN1 to IN2 transition, $V_{I}(IN1) = 3.3 V,$ $V_{I}(IN2) = 5 V,$ $V_{I}(EN) = 0 V$	$\label{eq:states} \begin{array}{l} T_J = 125^\circ C,\ C_L = 10\ \mu F,\\ I_L = 500\ mA\\ [Measure transition time\\ as 10–90\%\ rise time\ or\\ from\ 3.4\ V\ to\ 4.8\ V\ on\\ V_O(OUT)],\\ See\ Figure\ 1(b) \end{array}$		40	60		40	60	μs
<sup>t</sup> PLH1	Turn-on propagation delay from enable <sup>(1)</sup>	$V_{I(IN1)} = V_{I(IN2)} = 5 V$ Measured from enable to 10% of $V_{O(OUT)}$ , $V_{I}(VSNS) = 1.5 V$	TJ = 25°C, CL = 10 μF, IL = 500 mA, See Figure 1(a)		0.5			1		ms
<sup>t</sup> PHL1	Turn-off propagation delay from a disable <sup>(1)</sup>		$T_J = 25^{\circ}C$ , $C_L = 10 \mu$ F, $I_L = 500 \text{ mA}$ , See Figure 1(a)		3			5		ms
<sup>t</sup> PLH2	Switch-over rising propagation delay(1)	Logic 1 to Logic 0 transition on VSNS , VI(IN1) = 1.5 V, VI(IN2) = 5 V, VI(EN) = 0 V, Measured from VSNS to 10% of VO(OUT)	TJ = 25°C, CL = 10 μF, IL = 500 mA, See Figure 1(c)		40	100		40	100	μs
<sup>t</sup> PHL2	Switch-over falling propagation delay(1)	Logic 0 to Logic 1 transition on VSNS VI(IN1) = 1.5V, VI(IN2) = 5V, VI(EN) = 0 V, Measured from VSNS to 90% of VO(OUT)	TJ = 25°C, CL = 10 μF, IL = 500 mA, See Figure 1(c)	2	3	10	2	5	10	ms

(1) Not tested in production.



#### TRUTH TABLE

EN	V <sub>I(VSNS)</sub> > 0.8V	$V_{I(IN2)} > V_{I(IN1)}$	STAT	OUT(1)
	Yes	Х	0	IN1
0	No	No	0	IN1
	No	Yes	Hi-Z	IN2
1	Х	Х	0	Hi-Z

X = Don't care.

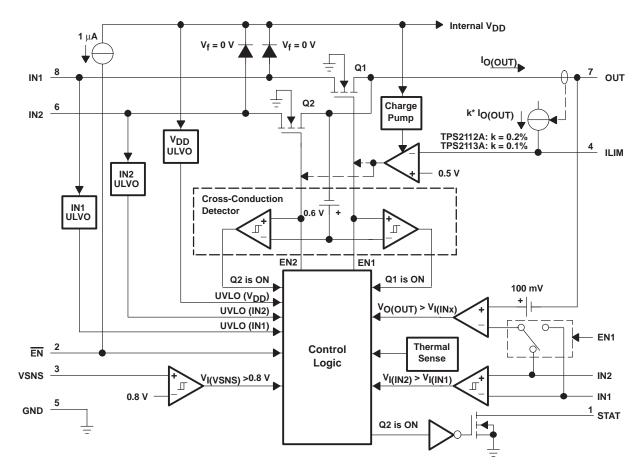
(1)The under-voltage lockout circuit causes the output OUT to go Hi-Z if the selected power supply does not exceed the IN1/IN2 UVLO, or if neither of the supplies exceeds the internal  $V_{DD}$  UVLO.

#### **Terminal Functions**

TERMINAL			DECODIDION					
NAME	NO.	1/0	DESCRIPTION					
EN	2	I	$\overline{\text{EN}}$ is a TTL- and CMOS-compatible input with a 1-µA pull-up. The truth table shown above illustrates the functionality of $\overline{\text{EN}}$ .					
GND	5	I	Ground					
IN1	8	I	Primary power switch input. The IN1 switch can be enabled only if the IN1 supply is above the UVLO threshold and at least one supply exceeds the internal $V_{DD}$ UVLO.					
IN2	6	I	Secondary power switch input. The IN2 switch can be enabled only if the IN2 supply is above the UVLO threshold and at least one supply exceeds the internal $V_{DD}$ UVLO.					
ILIM	4	I	A resistor R <sub>ILIM</sub> from ILIM to GND sets the current limit I <sub>L</sub> to $250/R_{ILIM}$ and $500/R_{ILIM}$ for the TPS2112A and TPS2113A, respectively.					
OUT	7	0	Power switch output					
STAT	1	0	STAT is an open-drain output that is Hi-Z if the IN2 switch is ON. STAT pulls low if the IN1 switch is ON or if OUT is Hi-Z (i.e., EN is equal to logic 0)					
VSNS	3	I	An internal power FET connects OUT to IN1 if the VSNS voltage is greater than 0.8 V. Otherwise, the FET connects OUT to the higher of IN1 and IN2. The truth table shown above illustrates the functionality of VSNS.					



## FUNCTIONAL BLOCK DIAGRAM





### PARAMETER MEASUREMENT INFORMATION

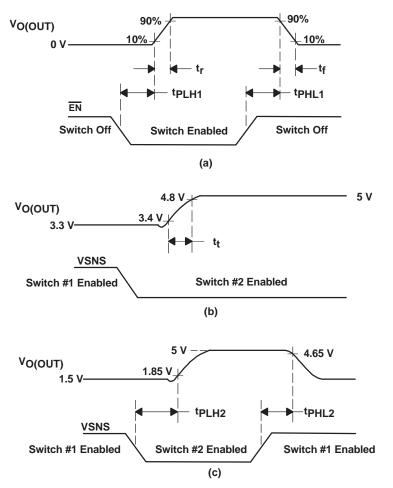
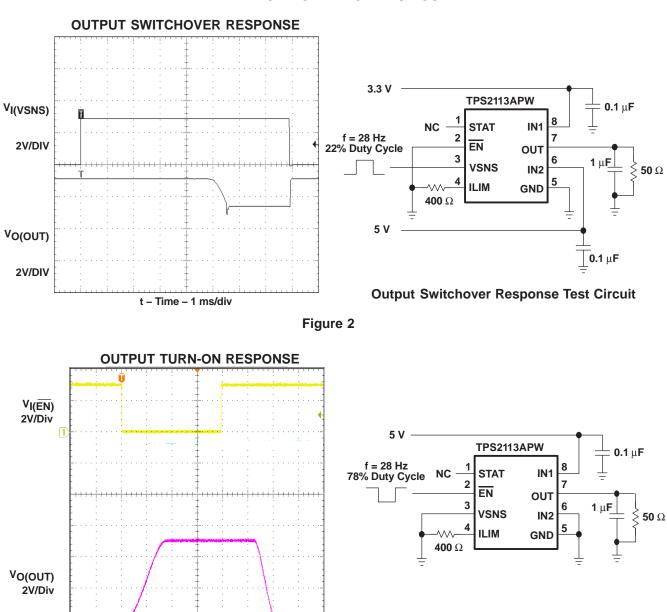


Figure 1. Propagation Delays and Transition Timing Waveforms



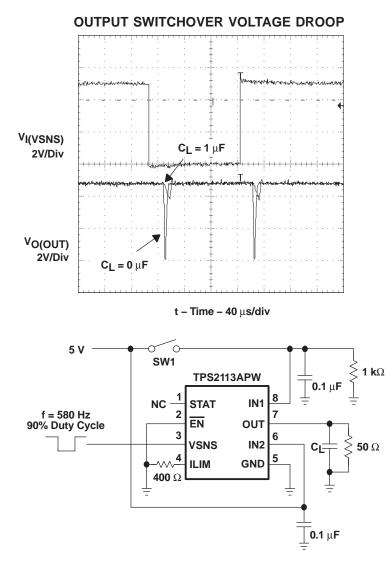


t – Time – 2 ms/div



**Output Turn-On Response Test Circuit** 



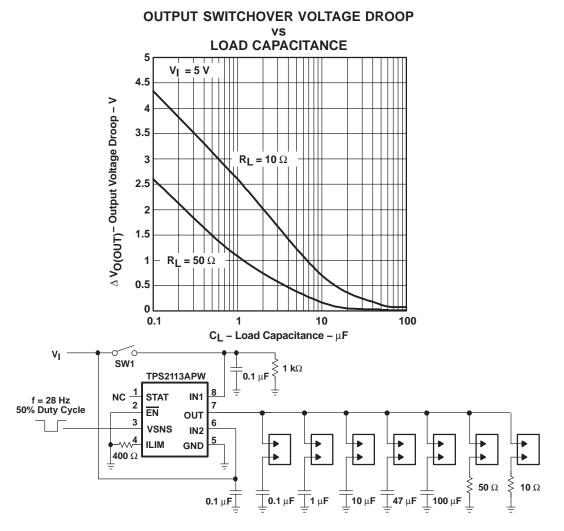


**Output Switchover Voltage Droop Test Circuit** 

Figure 4

NOTE: To initialize the TPS2113A for this test, set input VSNS equal to 0 V, turn on the 5 V supply, and then turn on switch SW1.





**Output Switchover Voltage Droop Test Circuit** 

Figure 5

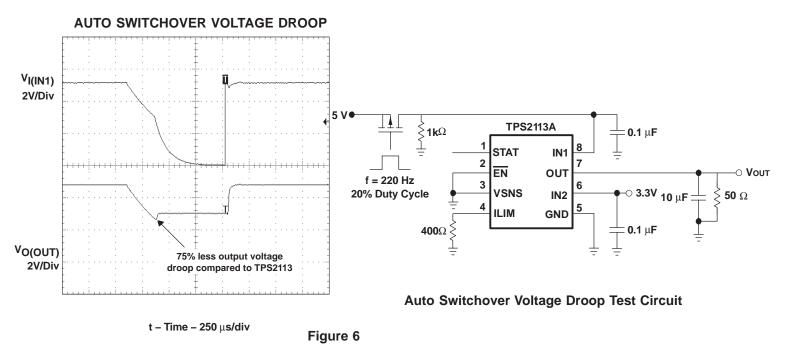
NOTE: To initialize the TPS2113A for this test, set input VSNS equal to 0 V, turn on the supply V<sub>i</sub>, and then turn on switch SW1.

<b>TPS2112A</b>	
TPS2113A	

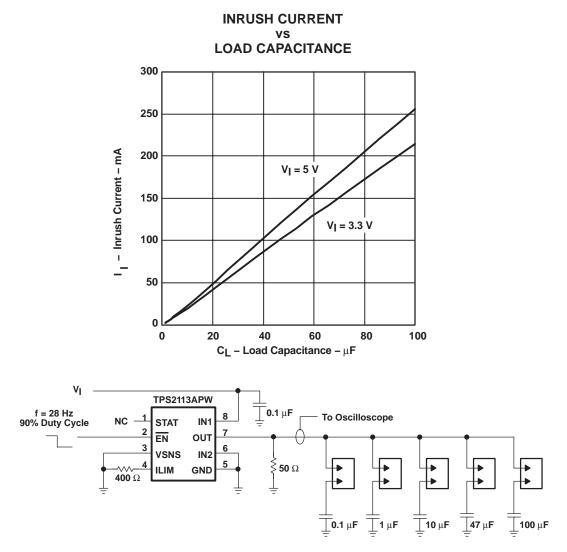
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#### **TYPICAL CHARACTERISTICS**



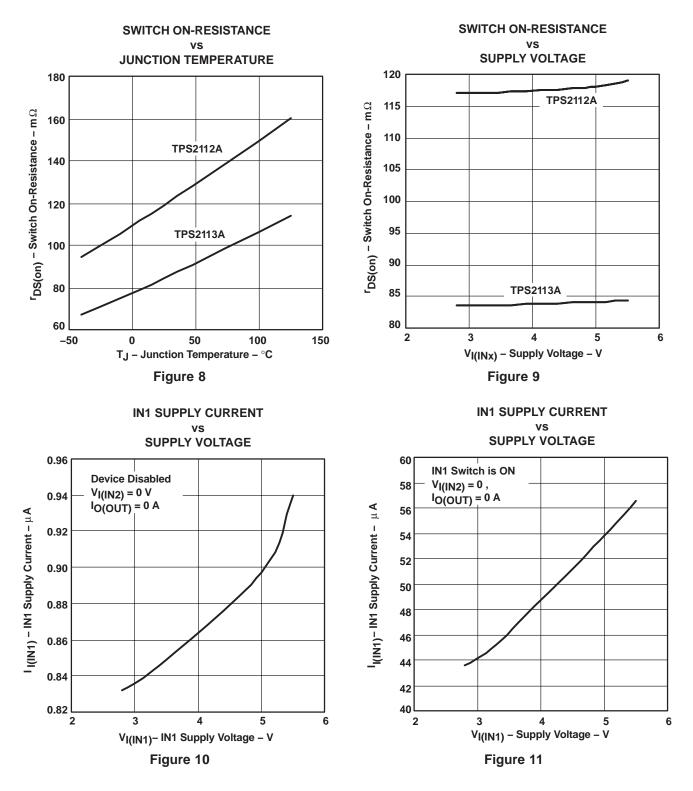


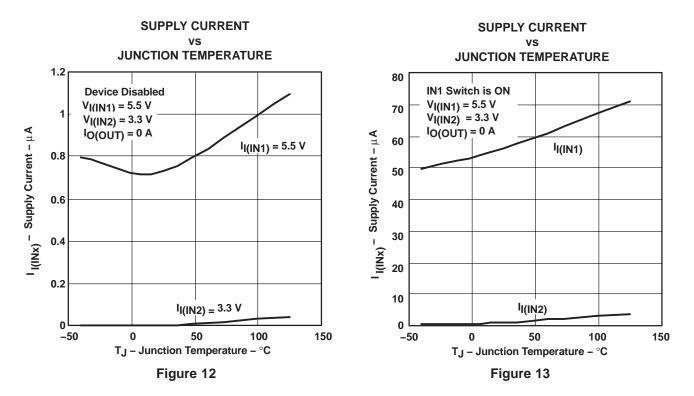


**Output Capacitor Inrush Current Test Circuit** 

Figure 7









#### **APPLICATION INFORMATION**

Some applications have two energy sources, one of which should be used in preference to another. Figure 14 shows a circuit that will connect IN1 to OUT until the voltage at IN1 falls below a user-specified value. Once the voltage on IN1 falls below this value, the TPS2112A/3A will select the higher of the two supplies. This usually means that the TPS2112A/3A will swap to IN2.

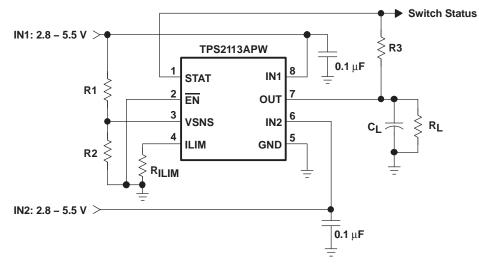


Figure 14. Auto-Selecting for a Dual Power Supply Application

In Figure 15, the multiplexer selects between two power supplies based upon the  $\overline{EN}$  logic signal. OUT connects to IN1 if  $\overline{EN}$  is logic 1; otherwise, OUT connects to IN2. The logic thresholds for the  $\overline{EN}$  terminal are compatible with both TTL and CMOS logic.

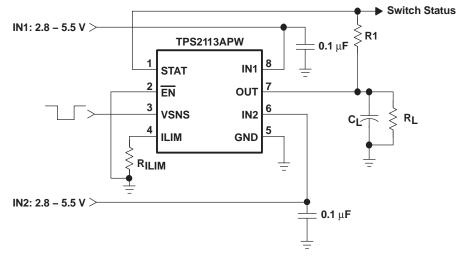


Figure 15. Manually Switching Power Sources



## DETAILED DESCRIPTION

#### **AUTO-SWITCHING MODE**

The TPS2112A/3A only supports the auto-switching mode. In this mode, OUT connects to IN1 if  $V_{I(VSNS)}$  is greater than 0.8 V, otherwise OUT connects to the higher of IN1 and IN2.

The VSNS terminal includes hysteresis equal to 3.75–7.5% of the threshold selected for transition from the primary supply to the higher of the two supplies. This hysteresis helps avoid repeated switching from one supply to the other due to resistive drops.

#### **N-CHANNEL MOSFETs**

Two internal high-side power MOSFETs implement a single-pole double-throw (SPDT) switch. Digital logic selects the IN1 switch, IN2 switch, or no switch (Hi-Z state). The MOSFETs have no parallel diodes so output-to-input current cannot flow when the FET is off. An integrated comparator prevents turn-on of a FET switch if the output voltage is greater than the input voltage.

#### **CROSS-CONDUCTION BLOCKING**

The switching circuitry ensures that both power switches will never conduct at the same time. A comparator monitors the gate-to-source voltage of each power FET and allows a FET to turn on only if the gate-to-source voltage of the other FET is below the turn-on threshold voltage.

#### **REVERSE-CONDUCTION BLOCKING**

When the TPS211xA switches from a higher-voltage supply to a lower-voltage supply, current can potentially flow back from the load capacitor into the lower-voltage supply. To minimize such reverse conduction, the TPS211xA will not connect a supply to the output until the output voltage has fallen to within 100 mV of the supply voltage. Once a supply has been connected to the output, it will remain connected regardless of output voltage.

#### **CHARGE PUMP**

The higher of supplies IN1 and IN2 powers the internal charge pump. The charge pump provides power to the current limit amplifier and allows the output FET gate voltage to be higher than the IN1 and IN2 supply voltages. A gate voltage that is higher than the source voltage is necessary to turn on the N-channel FET.

#### **CURRENT LIMITING**

A resistor R<sub>ILIM</sub> from ILIM to GND sets the current limit to 250/R<sub>ILIM</sub> and 500/R<sub>ILIM</sub> for the TPS2112A and TPS2113A, respectively. Setting resistor R<sub>ILIM</sub> equal to zero is not recommended as that disables current limiting.

#### **OUTPUT VOLTAGE SLEW-RATE CONTROL**

The TPS2112A/3A slews the output voltage at a slow rate when OUT switches to IN1 or IN2 from the Hi-Z state (see *Truth Table*). A slow slew rate limits the inrush current into the load capacitor. High inrush currents can glitch the voltage bus and cause a system to hang up or reset. It can also cause reliability issues—like pit the connector power contacts, when hot-plugging a load such as a PCI card. The TPS2112A/3A slews the output voltage at a much faster rate when OUT switches between IN1 and IN2. The fast rate minimizes the output voltage droop and reduces the output voltage hold-up capacitance requirement.

#### PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
TPS2112APW	ACTIVE	TSSOP	PW	8	150	None	CU NIPDAU	Level-1-220C-UNLIM
TPS2112APWR	ACTIVE	TSSOP	PW	8	2000	None	CU NIPDAU	Level-1-220C-UNLIM
TPS2113APW	ACTIVE	TSSOP	PW	8	150	None	CU NIPDAU	Level-1-220C-UNLIM
TPS2113APWR	ACTIVE	TSSOP	PW	8	2000	None	CU NIPDAU	Level-1-220C-UNLIM
TPS2113APWRG4	PREVIEW	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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# **MECHANICAL DATA**

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

# PW (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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